7-102619-3 - ACTIVE

AMPMODU | AMPMODU Headers

TE Internal #: 7-102619-3 PCB Mount Header, Vertical, Board-to-Board, 50 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers

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Connectors > PCB Connectors > PCB Headers & Receptacles

PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 50

Number of Rows: 2

Features

Product Type Features

PCB Connector Assembly Type

Connector System

Header Type

Connector & Contact Terminates To

Configuration Features

PCB Mount Header

Board-to-Board

Fully Shrouded

Printed Circuit Board



Connector Contact Load Condition	Fully Loaded
PCB Mount Orientation	Vertical
Number of Positions	50
Number of Rows	2
Board-to-Board Configuration	Parallel
Electrical Characteristics	
Insulation Resistance	5000 ΜΩ
Dielectric Withstanding Voltage (Max)	750 Vrms
Body Features	
Connector Profile	
	Standard
Primary Product Color	Black
Primary Product Color	
Primary Product Color Contact Features	Black
Primary Product Color Contact Features Mating Square Post Dimension	Black .64 mm[.025 in]

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Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.381 μm[15 μin]
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Post & Tail Length	3.18 mm[.125 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Retention	With
Mating Retention Type	Detent Window
Mating Alignment	With
Mating Alignment Type	Polarization
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	Thermoplastic
Dimensions	
Row-to-Row Spacing	2.54 mm[.1 in]
PCB Thickness (Recommended)	1.4 mm[.055 in]
Usage Conditions	
Housing Temperature Rating	Standard
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Circuit Application	Signal
ndustry Standards	
Agency/Standard	CSA

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Approved Standards	CSA LR7189, UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	64
Packaging Type	Package
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	BFR/CFR/PVC Free, but Br/Cl >900 ppm in other sources.
Solder Process Capability	Wave solder capable to 240°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

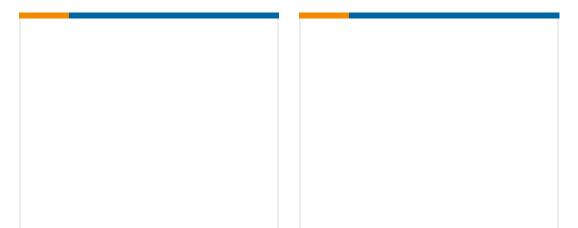
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TE Part # 1-88179-2 050 HOUSING FFC RCPT DR 100CL

Also in the Series AMPMODU Headers

PCB Connector Mounting(1)	PCB Connector Shrouds(1)	PCB Headers & Receptacles(4875)	PCB Latches, Locks & Retainers(1)



Wire-to-Board Connector AssembliesWire-to-Board& Housings(5)

Wire-to-Board Connector Contacts(65)

Customers Also Bought

TE Part #166053-1 COSI PIN CONTACT HD20 DF; 24-20 AWG	TE Part #102241-6 08 MODIV HSG COMP SR .100 POL	TE Part #1-770969-1 06P MINI UMNL R/A HDR ASSY LF	TE Part #1734193-1 WTB Socket,Terminal 80u" Tin
TE Part #350874-3	TE Part #2-87631-9	TE Part #440146-4	TE Part #4-2176456-1
UMNL SOK 18-14 .0125 PTPPHBZ	34 MODIV HSG COMP DR .100 POL	1.25mm WTB Socket,Housing,4p	CPF 0603 2R61 0.1% 25ppm 1K RL

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TE Part #1614958-2 CPF 0805 1R0 0.1% 25ppm 1K RL

Documents

Product Drawings 50 MODII HDR DRST SHRD .100CL

English

CAD Files **Customer View Model** ENG_CVM_7-102619-3_K.3d_igs.zip

English

Customer View Model

ENG_CVM_7-102619-3_K.3d_stp.zip

English

Customer View Model

ENG_CVM_7-102619-3_K.2d_dxf.zip

English

3D PDF

English

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Datasheets & Catalog Pages AMPMODU_INTERCONNECTION_SYSTEM_SECTION5

English

Product Environmental Compliance

Product Compliance

English

Product Compliance

English